



## SPECIFICATION FOR APPROVAL

CUSTOMER			
NOMINAL FREQUENCY	26.000000 MHz		
PRODUCT TYPE	TYPE FW 2.0x1.6 SEAM SEALED CRYSTAL		
SPEC. NO. ( P/N )	FW2600055Q		
CUSTOMER P/N			
ISSUE DATE	June 13, 2018		
VERSION	В		

APPROVED	PREPARED	QA	
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## **Diodes Incorporated**

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- \*Pb-free
- \*RoHS Compliant
- \*HF-Halogen Free
- \*REACH Compliant
- \*AEC-Q200 Compliant

FW2600055Q

VER. B 13-Jun-18

## **VERSION HISTORY**

Version No.	Version Date	Description	Notes
Α	Aug.17,2017	Initial Release	
В	Jun.13,2018	Updated Logo	

## FW2600055Q

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#### **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	26.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	10	pF	
Calibration Tolerance	FL	±10	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +85	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±30	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	Max.
Equivalent Series Resistance	ESR	90	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25°C		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	ΜΩ	Min

※ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



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#### **AEC-Q200 RELIABILITY TEST SPECIFICATIONS:**

#### 1. Initial

1.1 Physical Dimensions: JESD22, Method JB1-100

1.2 External Visual: MIL-STD-883, Method 2009

1.3 Freq. Vs. Temperature: Per Specification/Datasheet

#### 2. Mechanical

2.1 Mechanical Shock: MIL-STD-202 Method 213

2.2 Vibration: MIL-STD-202 Method 204

2.3 Solderability: J-STD-002

2.4 Board Flex: AEC Q200-005

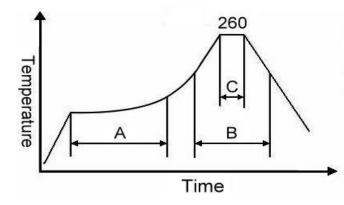
2.5 Terminal Strength (SMD): AEC Q200-006

#### 3.Environmental

- 3.1 Temp Cycle: JESD22, Method JA-104
- 3.2 Resistance to Solder Heat: MIL-STD-202 Method 210
- 3.3 High Temperature Operating Life: MIL-STD-202, Method 108
- 3.4 High Temp Exposure: MIL-STD-202, Method 108
- 3.5 High Temp & High Humidity: MIL-STD-202, Method 103
- 3.6 Thermal Shock: MIL-STD-202, Method 107

#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



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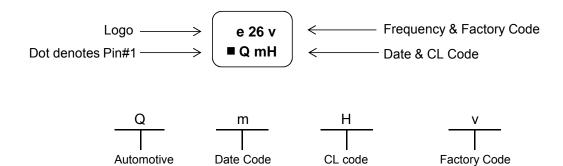
	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec



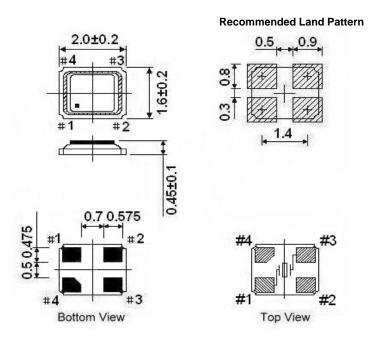
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#### **MARKING**



#### MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)



\*\* Recommended - Pin 1 & 3: CRYSTAL Pin 2 & 4: GND

#### Notes:

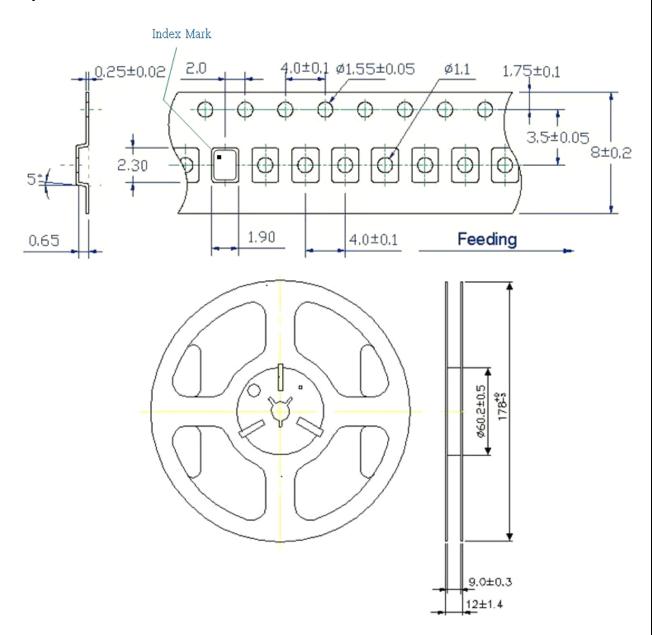
- Package drawings are for reference only, and the appearances of objects may vary.
  Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.



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## Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

**DECDES** 

# **TYPE FW 2.0x1.6 SEAM SEALED CRYSTAL** FW2600055Q VER. B 13-Jun-18 **PACKING** Start حاستانت Begin **End** 3000pcs-Product Tape Inner Packing Carton Storeroom Label Blue Qualified Label Storeroom Storeroom Label Deliver Packing Carton (L29\*W24\*H30) Green Qualified

